TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LVX32F,TC74LVX32FN,TC74LVX32FT

Quad 2-Input OR Gate

The TC74LVX32F/ FN/ FT is a high-speed CMOS 2-input OR gate fabricated with silicon gate CMOS technology. Designed for use in 3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

This device is suitable for low-voltage and battery operated systems.

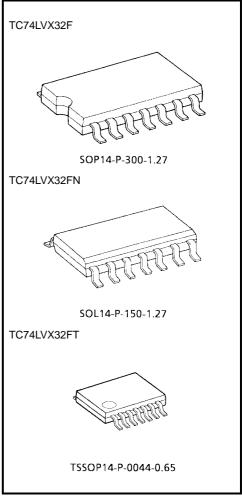
The internal circuit is composed of 4 stages including buffer output, which provide high noise immunity and stable output.

An input protection circuit ensures that 0 to 5.5V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

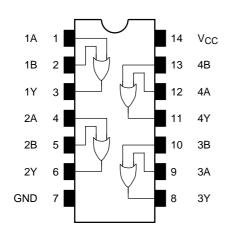
- High-speed: $t_{pd} = 4.4 \text{ ns (typ.) (V}_{CC} = 3.3 \text{ V})$
- Low power dissipation: $I_{CC} = 2 \mu A \text{ (max) (Ta} = 25 ^{\circ}\text{C)}$
- Input voltage level: $V_{IL} = 0.8 \text{ V (max)} (V_{CC} = 3 \text{ V})$ $V_{IH} = 2.0 \text{ V (min)} (V_{CC} = 3 \text{ V})$
- · Power-down protection provided on all inputs
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Low noise: VOLP = 0.5 V (max)
- Pin and function compatible with 74HC32

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight SOP14-P-300-1.27: 0.18 g (typ.) SOL14-P-150-1.27: 0.12 g (typ.) TSSOP14-P-0044-0.65: 0.06 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol

1A	(1)	≥ 1	(3)
1B ·	(2)		1Y
2A	(4)		(6)
	(5)		2Y
2B	(9)		
3A ·	. ,		(8)
3B	(10)		3Y
	(12)		(4.4)
4A ·	(13)		(11)
4B ·	(13)		41

Truth Table

Inp	Outputs	
Α	В	Υ
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н

Maximum Ratings

Characteristics	Symbol	Rating	Unit	
Supply voltage range	V _{CC}	-0.5 to 7.0	V	
DC input voltage	V _{IN}	-0.5 to 7.0	٧	
DC output voltage	V _{OUT}	-0.5 to $V_{CC} + 0.5$	٧	
Input diode current	I _{IK}	-20	mA	
Output diode current	I _{OK}	±20	mA	
DC output current	lout	±25	mA	
DC V _{CC} /ground current	I _{CC}	±50	mA	
Power dissipation	P _D	180	mW	
Storage temperature	T _{stg}	-65 to 150	°C	

Recommended Operating Conditions

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0 to 3.6	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100	ns/V



Electrical Characteristics

DC Characteristics

Characteristics		Symbol	Test	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
			Ţ,		V _{CC} (V)	Min	Тур.	Max	Min	Max	
					2.0	1.5	_	_	1.5	_	
	H-level	V _{IH}	_		3.0	2.0	_	_	2.0	_	1
Input voltage					3.6	2.4	_	_	2.4	_	V
input voltage					2.0	_	_	0.5	_	0.5	v
	L-level	V_{IL}	_		3.0	_	_	0.8	_	0.8	
					3.6	_	_	0.8	_	0.8	
	H-level	evel V _{OH}	V _{OH} V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -50 \ \mu A$	2.0	1.9	2.0	_	1.9	_	
				$I_{OH} = -50 \ \mu A$	3.0	2.9	3.0	_	2.9	_	
Output voltage				$I_{OH} = -4 \text{ mA}$	3.0	2.58	_	_	2.48	_	V
Output voltage			l l	$I_{OL} = 50 \mu A$	2.0	_	0	0.1	_	0.1	\ \ \ \
	L-level	V _{OL}		$I_{OL} = 50 \mu A$	3.0	_	0	0.1	_	0.1	
				$I_{OL} = 4 \text{ mA}$	3.0	_	_	0.36	_	0.44	
Input leakage current		I _{IN}	V _{IN} = 5.5 V or GND		3.6			±0.1	_	±1.0	μΑ
Quiescent supply current		Icc	$V_{IN} = V_{CC}$	or GND	3.6	_	_	2.0	_	20.0	μΑ

AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Ta = 25° C			Ta = -40 to 85°C					
			V _{CC} (V) C _L (pF) Min		Тур.	Max	Min	Max		
	t		2.7	15		5.8	10.7	1.0	13.5	
Propagation delay time	t _{pLH}		2.1	50		8.3	14.2	1.0	17.0	ns
Topagation delay time	t _{pHL}	_	3.3 ± 0.3	15		4.4	6.6	1.0	8.0	113
				50	_	6.9	10.1	1.0	11.5	
Output to output skew	t _{osLH}	(Note 1)	2.7	50	_	_	1.5		1.5	ns
Output to output skew	t _{osHL}		3.3 ± 0.3	50	_	_	1.5	_	1.5	115
Input capacitance	C _{IN}			(Note 2)	_	4	10	_	10	pF
Power dissipation capacitance	C _{PD}	(Note 3)		_	14	_	_	_	pF	

Note 1: Parameter guaranteed by design. $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, \, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$

Note 2: Parameter guaranteed by design.

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

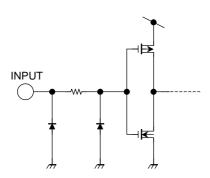
 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per gate)}$



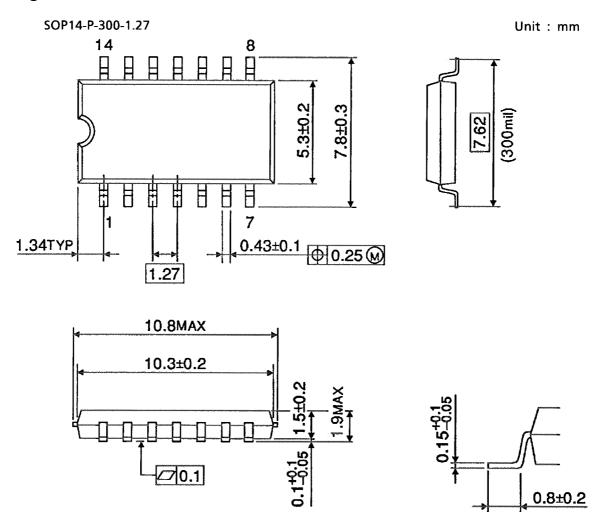
Noise Characteristics (Ta = 25°C, input: $t_r = t_f = 3$ ns, $C_L = 50$ pF)

Characteristics		Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Quiet output maximum dynamic	V _{OL}	V _{OLP}	_	3.3	0.3	0.5	٧
Quiet output minimum dynamic	V _{OL}	V _{OLV}	_	3.3	-0.3	-0.5	٧
Minimum high level dynamic input voltage	V _{IH}	V _{IHD}	_	3.3	_	2.0	V
Maximum low level dynamic input voltage	V _{IL}	V _{ILD}	_	3.3		0.8	٧

Input Equivalent Circuit



Package Dimensions

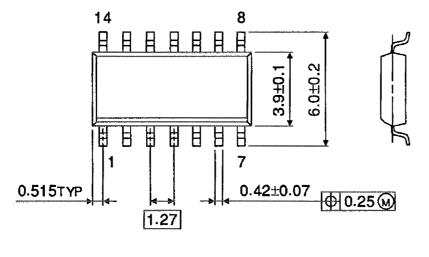


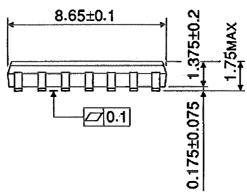
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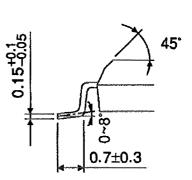
Weight: 0.18 g (typ.)

Package Dimensions









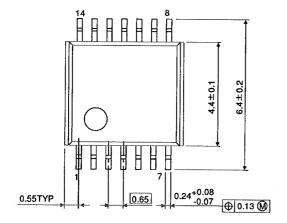
Weight: 0.12 g (typ.)

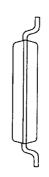
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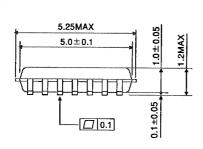
Unit: mm

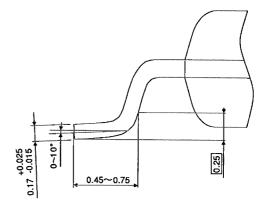
Package Dimensions

TSSOP14-P-0044-0.65









Weight: 0.06 g (typ.)

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